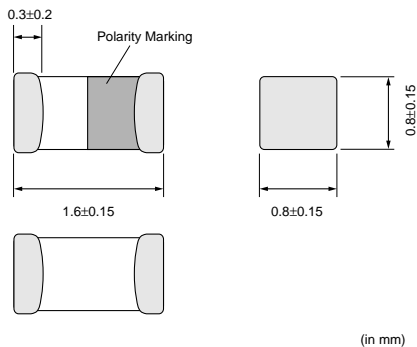


Chip Coils for High Frequency Monolithic Type

LQG18H Series (0603 Size)

Dimension



Packaging

| Code | Packaging | Minimum Quantity |
|------|------------------|------------------|
| D | 180mm Paper Tape | 4000 |
| J | 330mm Paper Tape | 10000 |
| B | Bulk(Bag) | 1000 |

Rated Value (□: packaging code)

| Part Number | Inductance | Test Frequency | Rated Current | Max. of DC Resistance | Q (min.) | Test Frequency | Self Resonance Frequency (min.) |
|----------------|-------------|----------------|---------------|-----------------------|----------|----------------|---------------------------------|
| LQG18HN1N2S00□ | 1.2nH±0.3nH | 100MHz | 500mA | 0.10ohm | 12 | 100MHz | 6000MHz |
| LQG18HN1N5S00□ | 1.5nH±0.3nH | 100MHz | 500mA | 0.10ohm | 12 | 100MHz | 6000MHz |
| LQG18HN1N8S00□ | 1.8nH±0.3nH | 100MHz | 500mA | 0.10ohm | 12 | 100MHz | 6000MHz |
| LQG18HN2N2S00□ | 2.2nH±0.3nH | 100MHz | 500mA | 0.10ohm | 12 | 100MHz | 6000MHz |
| LQG18HN2N7S00□ | 2.7nH±0.3nH | 100MHz | 500mA | 0.15ohm | 12 | 100MHz | 6000MHz |
| LQG18HN3N3S00□ | 3.3nH±0.3nH | 100MHz | 500mA | 0.15ohm | 12 | 100MHz | 6000MHz |
| LQG18HN3N9S00□ | 3.9nH±0.3nH | 100MHz | 450mA | 0.15ohm | 12 | 100MHz | 6000MHz |
| LQG18HN4N7S00□ | 4.7nH±0.3nH | 100MHz | 450mA | 0.20ohm | 12 | 100MHz | 6000MHz |
| LQG18HN5N6S00□ | 5.6nH±0.3nH | 100MHz | 430mA | 0.20ohm | 12 | 100MHz | 5000MHz |
| LQG18HN6N8J00□ | 6.8nH±5% | 100MHz | 430mA | 0.25ohm | 12 | 100MHz | 5000MHz |
| LQG18HN8N2J00□ | 8.2nH±5% | 100MHz | 400mA | 0.25ohm | 12 | 100MHz | 4000MHz |
| LQG18HN10NJ00□ | 10nH±5% | 100MHz | 400mA | 0.30ohm | 12 | 100MHz | 3500MHz |
| LQG18HN12NJ00□ | 12nH±5% | 100MHz | 400mA | 0.35ohm | 12 | 100MHz | 3000MHz |
| LQG18HN15NJ00□ | 15nH±5% | 100MHz | 350mA | 0.40ohm | 12 | 100MHz | 2800MHz |
| LQG18HN18NJ00□ | 18nH±5% | 100MHz | 350mA | 0.45ohm | 12 | 100MHz | 2600MHz |
| LQG18HN22NJ00□ | 22nH±5% | 100MHz | 300mA | 0.50ohm | 12 | 100MHz | 2300MHz |
| LQG18HN27NJ00□ | 27nH±5% | 100MHz | 300mA | 0.55ohm | 12 | 100MHz | 2000MHz |
| LQG18HN33NJ00□ | 33nH±5% | 100MHz | 300mA | 0.60ohm | 12 | 100MHz | 1700MHz |
| LQG18HN39NJ00□ | 39nH±5% | 100MHz | 300mA | 0.65ohm | 12 | 100MHz | 1500MHz |
| LQG18HN47NJ00□ | 47nH±5% | 100MHz | 300mA | 0.70ohm | 12 | 100MHz | 1200MHz |
| LQG18HN56NJ00□ | 56nH±5% | 100MHz | 300mA | 0.75ohm | 12 | 100MHz | 1100MHz |
| LQG18HN68NJ00□ | 68nH±5% | 100MHz | 300mA | 0.80ohm | 12 | 100MHz | 1000MHz |
| LQG18HN82NJ00□ | 82nH±5% | 100MHz | 300mA | 0.85ohm | 12 | 100MHz | 900MHz |

Operating Temperature Range: -40°C to +85°C


Only for reflow soldering.

Continued on the following page.

● This data sheet is applied for CHIP COIL used for General Electronics equipment for your design.

Note:

- This datasheet is downloaded from the website of Murata Manufacturing co., Ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

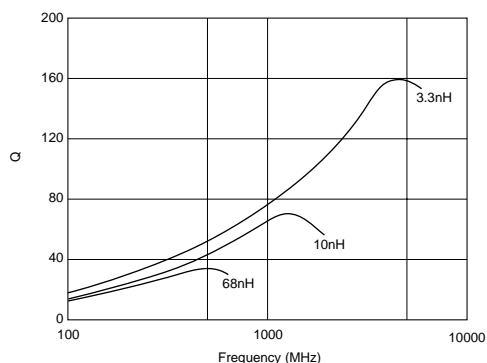
 Continued from the preceding page.

| Part Number | Inductance | Test Frequency | Rated Current | Max. of DC Resistance | Q (min.) | Test Frequency | Self Resonance Frequency (min.) |
|----------------|------------|----------------|---------------|-----------------------|----------|----------------|---------------------------------|
| LQG18HNR10J00□ | 100nH±5% | 100MHz | 300mA | 0.90ohm | 12 | 100MHz | 800MHz |

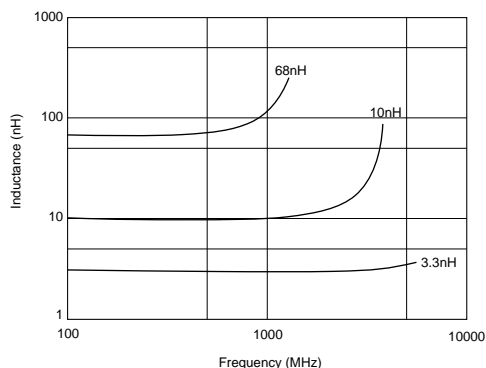
Operating Temperature Range: -40°C to +85°C

Only for reflow soldering.

■ Q - Frequency Characteristics (Typ.)



■ Inductance - Frequency Characteristics (Typ.)



■ ⚠ Caution/Notice

⚠ Caution (Rating)

Do not use products beyond the rated current as this may create excessive heat.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

● This data sheet is applied for CHIP COIL used for General Electronics equipment for your design.

⚠ Note:

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